

Integrated Circuit, Hybrid, and Multichip Module Package Design Guidelines: A Focus on Reliability (Hardback)



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Reviews

This publication will be worth purchasing. It really is written in simple terms instead of difficult to understand. It has been designed in an exceptionally simple way and is particularly only right after I finished reading this ebook in which basically modified me, altered the way I believe.

(Prof. Loyce Runolfsson Jr.)

INTEGRATED CIRCUIT, HYBRID, AND MULTICHIP MODULE PACKAGE DESIGN GUIDELINES: A FOCUS ON RELIABILITY (HARDBACK)

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